



P-SMP

High Power Board-to-Board Interconnection

This newly developed P-SMP interconnection provides an excellent continuous power handling up to 200 W at 2,2 GHz. A compact design, containing of two pcb connectors and one bullet allows an optimized compensation of axial and radial misalignment by featuring a similar size to standard SMA connectors. With a strong focus on robustness this connector solution provides a high reliability. Excellent RF capabilities make P-SMP connectors ideal for applications up to 10 GHz.

Product features:

- High RF power transmission between two boards or one board and cables transition
- Permits axial misalignment of: max. ±1 mm
 Permits radial misalignment of: max. 4°
- Enables minimum board to board distances of 12.6 mm
- · Robust mechanical design

Characteristics:

Impedance: 50 OhmFrequency range: DC – 10 GHz

• Return loss: \geq 32 dB @ DC to 3 GHz

≥26 dB @ 3 GHz to 6 GHz

• Power handling: up to 200 W @ 2.2 GHz

Mating cycles: ≥ 500 cycles (type: limited detent)
 For further details please refer to product data sheets

Applications:

High power board to board and board to cable interconnections where RF signals up to 200 W @ 2.2 GHz have to be transmitted continuously. Typical usages are power amplifiers in base stations.



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